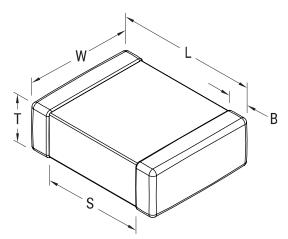


C1206X104G3GEC

ESD SMD Comm COG, Ceramic, 0.1 uF, 2%, 25 VDC, COG, SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I, 1206, 1.5 mm



Click here for the 3D model.

General Information	
Series	ESD SMD Comm COG
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I
Features	Temperature Stable, Low ESR, Class I
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	36 mg
Shelf Life	78 Weeks
MSL	1

1206
3.3mm +/-0.4mm
1.6mm +/-0.35mm
1.6mm +/-0.20mm
1.5mm MIN
0.6mm +/-0.25mm

Bulk, Bag

1

Packaging Specifications

Packaging Packaging Quantity

0.1 uF
1 kHz 1.0Vrms
2%
25 VDC
25,000 V ESD Level
62.5 VDC
-55/+125°C
COG
30 ppm/C, 1kHz 1.0Vrms
0.1% 1 kHz 1.0Vrms
0% Loss/Decade Hour
10 GOhms

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